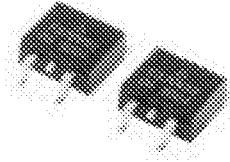


MITSUBISHI Nch POWER MOSFET

# FS70VSH-06

HIGH-SPEED SWITCHING USE

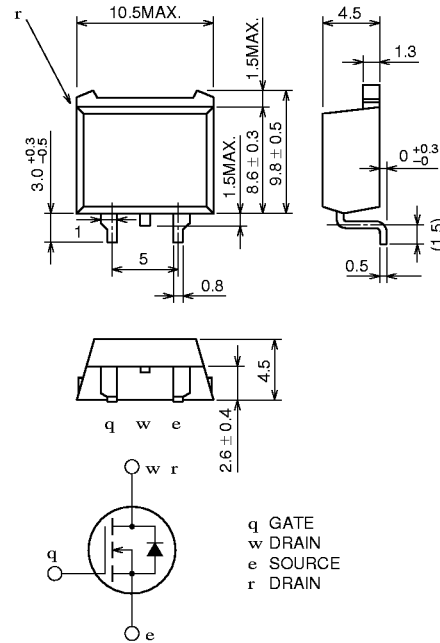
## FS70VSH-06



- ∨ 2.5V DRIVE
- ∨ V<sub>DSS</sub> ..... 60V
- ∨ r<sub>DS (ON)</sub> (MAX) ..... 7.5mΩ
- ∨ I<sub>D</sub> ..... 70A
- ∨ Integrated Fast Recovery Diode (TYP.) ..... 110ns

### OUTLINE DRAWING

Dimensions in mm



TO-220S

### APPLICATION

Motor control, Lamp control, Solenoid control  
DC-DC converter, etc.

### MAXIMUM RATINGS (T<sub>c</sub> = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
V <sub>DSS</sub>	Drain-source voltage	V <sub>GS</sub> = 0V	60	V
V <sub>GSS</sub>	Gate-source voltage	V <sub>DS</sub> = 0V	±10	V
I <sub>D</sub>	Drain current		70	A
I <sub>DM</sub>	Drain current (Pulsed)		280	A
I <sub>DA</sub>	Avalanche drain current (Pulsed)	L = 100μH	70	A
I <sub>S</sub>	Source current		70	A
I <sub>SM</sub>	Source current (Pulsed)		280	A
P <sub>D</sub>	Maximum power dissipation		125	W
T <sub>ch</sub>	Channel temperature		-55 ~ +150	°C
T <sub>stg</sub>	Storage temperature		-55 ~ +150	°C
—	Weight	Typical value	1.2	g

Feb. 1999

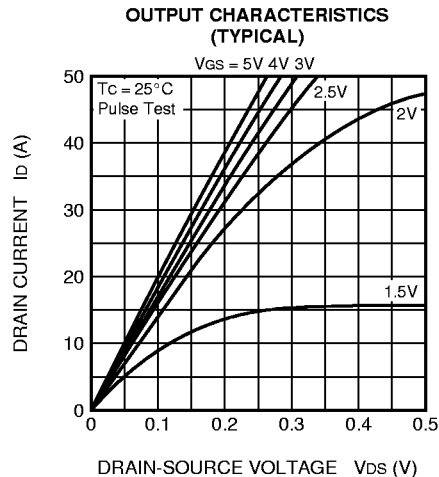
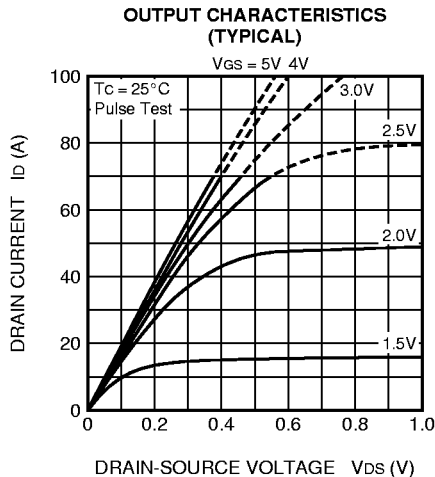
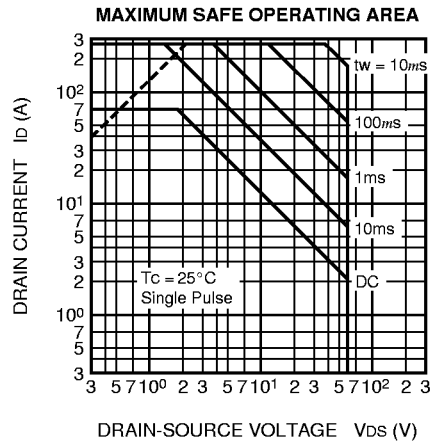
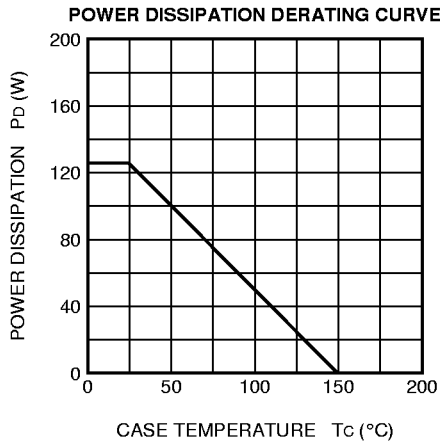
# FS70VSH-06

HIGH-SPEED SWITCHING USE

## ELECTRICAL CHARACTERISTICS (T<sub>ch</sub> = 25°C)

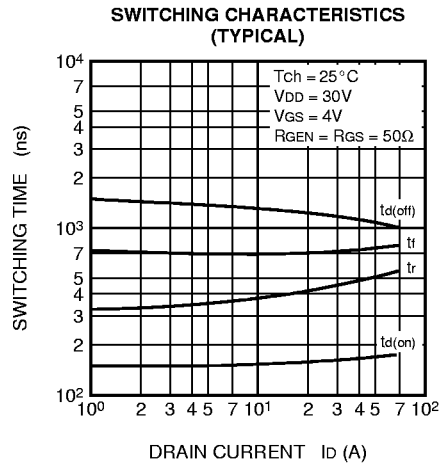
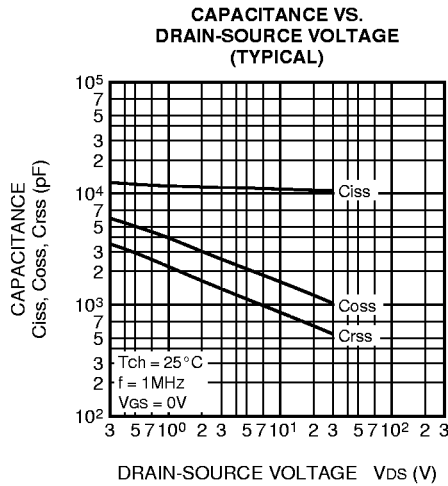
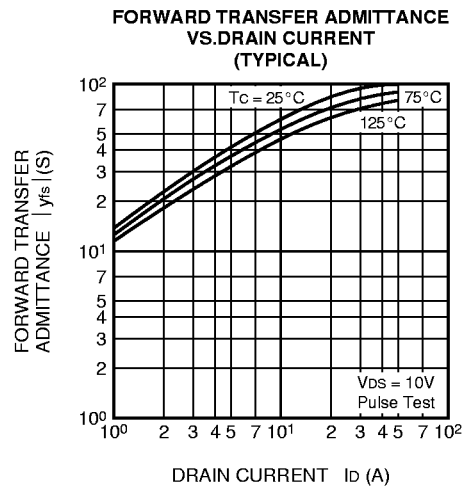
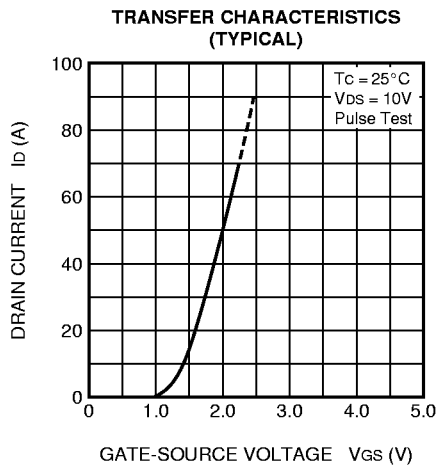
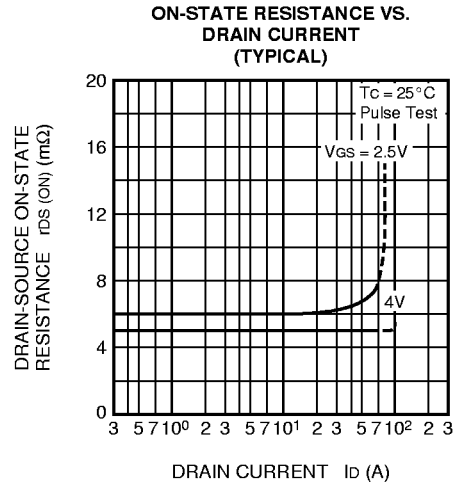
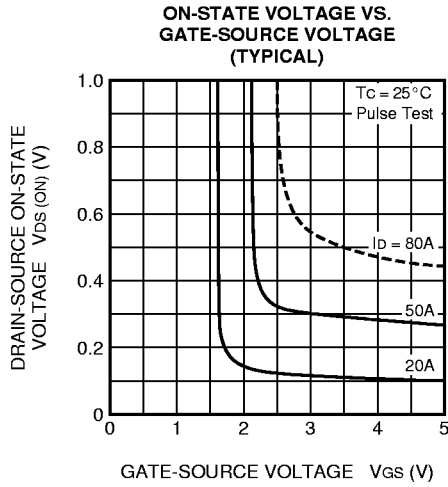
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 1mA, V <sub>GS</sub> = 0V	60	—	—	V
I <sub>GSS</sub>	Gate-source leakage current	V <sub>GS</sub> = ±10V, V <sub>DS</sub> = 0V	—	—	±0.1	μA
I <sub>DSS</sub>	Drain-source leakage current	V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V	—	—	0.1	mA
V <sub>GS(th)</sub>	Gate-source threshold voltage	I <sub>D</sub> = 1mA, V <sub>DS</sub> = 10V	0.6	0.9	1.2	V
r <sub>DS(ON)</sub>	Drain-source on-state resistance	I <sub>D</sub> = 35A, V <sub>GS</sub> = 4V	—	5.5	7.5	mΩ
r <sub>DS(ON)</sub>	Drain-source on-state resistance	I <sub>D</sub> = 35A, V <sub>GS</sub> = 2.5V	—	6.3	8.6	mΩ
V <sub>DS(ON)</sub>	Drain-source on-state voltage	I <sub>D</sub> = 35A, V <sub>GS</sub> = 4V	—	0.19	0.26	V
y <sub>fs</sub>	Forward transfer admittance	I <sub>D</sub> = 35A, V <sub>DS</sub> = 10V	—	79	—	S
C <sub>iss</sub>	Input capacitance	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1MHz	—	11000	—	pF
C <sub>oss</sub>	Output capacitance		—	1750	—	pF
C <sub>rss</sub>	Reverse transfer capacitance		—	950	—	pF
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 30V, I <sub>D</sub> = 35A, V <sub>GS</sub> = 4V, R <sub>GEN</sub> = R <sub>GS</sub> = 50Ω	—	150	—	ns
t <sub>r</sub>	Rise time		—	440	—	ns
t <sub>d(off)</sub>	Turn-off delay time		—	1100	—	ns
t <sub>f</sub>	Fall time		—	740	—	ns
V <sub>SD</sub>	Source-drain voltage	I <sub>S</sub> = 35A, V <sub>GS</sub> = 0V	—	1.0	1.5	V
R <sub>th(ch-c)</sub>	Thermal resistance	Channel to case	—	—	1.00	°C/W
t <sub>rr</sub>	Reverse recovery time	I <sub>S</sub> = 70A, dis/dt = -100A/μs	—	110	—	ns

## PERFORMANCE CURVES



FS70VSH-06

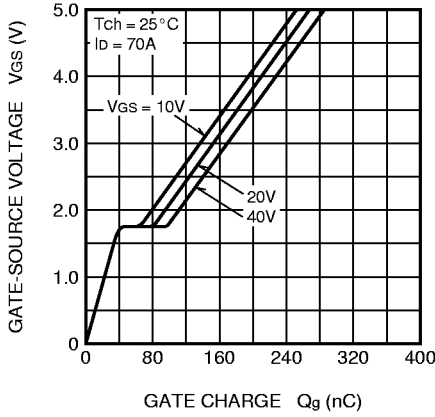
HIGH-SPEED SWITCHING USE



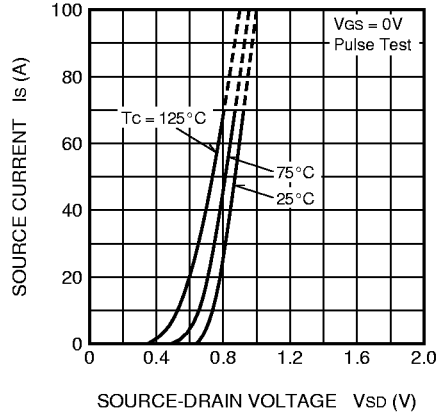
FS70VSH-06

HIGH-SPEED SWITCHING USE

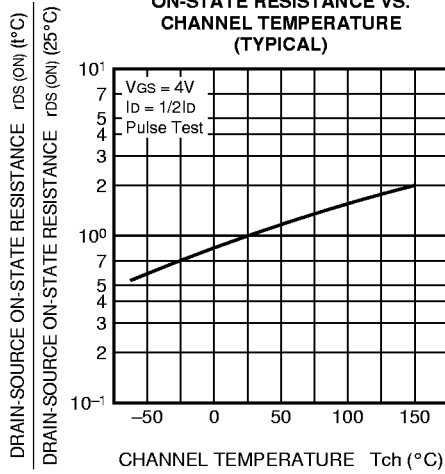
GATE-SOURCE VOLTAGE VS. GATE CHARGE (TYPICAL)



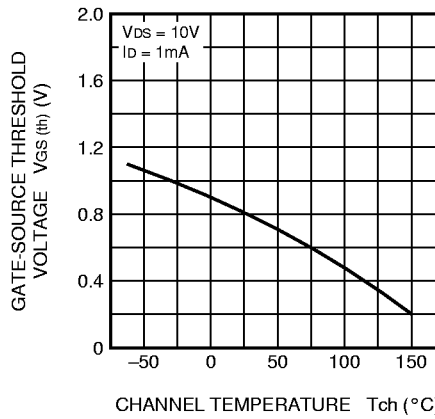
SOURCE-DRAIN DIODE FORWARD CHARACTERISTICS (TYPICAL)



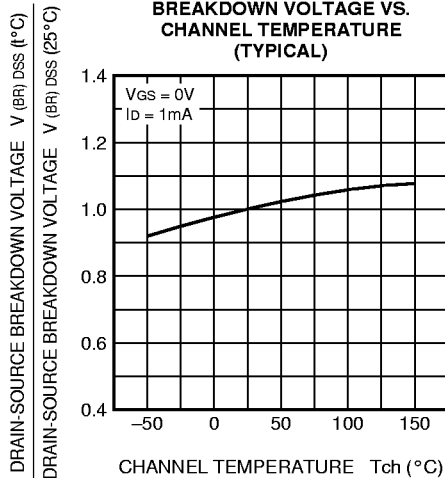
ON-STATE RESISTANCE VS. CHANNEL TEMPERATURE (TYPICAL)



THRESHOLD VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



BREAKDOWN VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS

